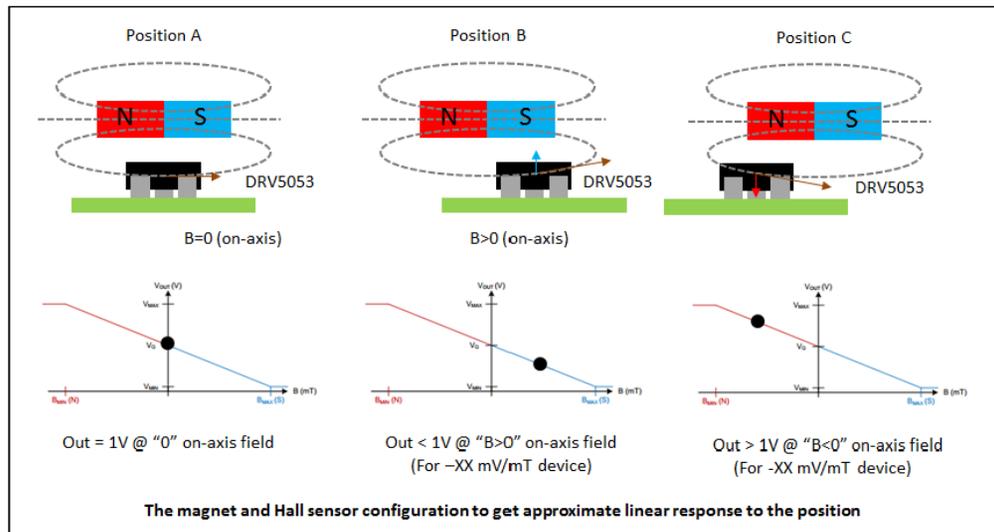
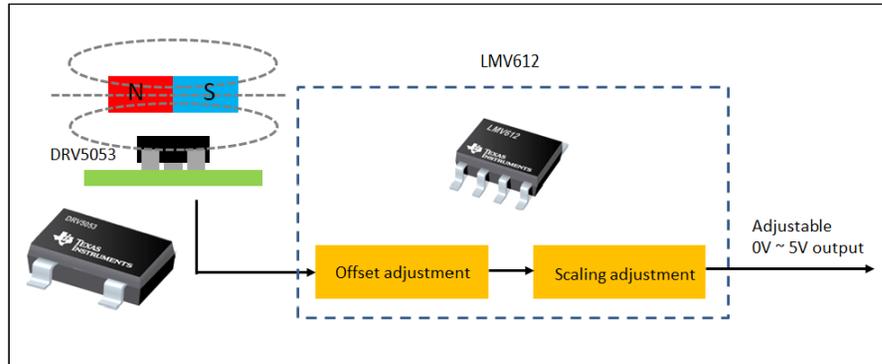


Revision History				
Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A

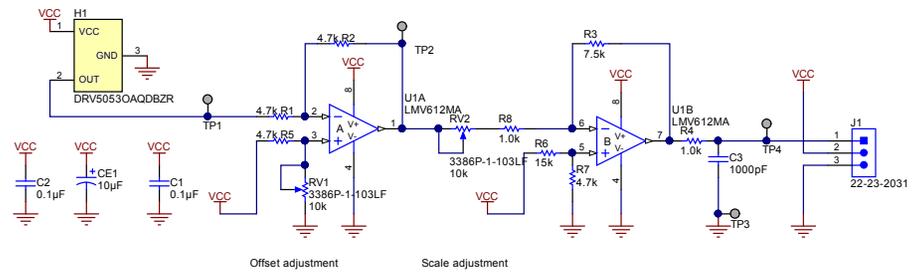


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Orderable: N/A	Designed for: Public Release	Mod. Date: 11/9/2015
TID #: 00642	Project Title: Foot Controller Using Analog Hall Sensor	
Number: TIDA-00642 Rev: E1	Sheet Title:	
Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 1 of 3
Drawn By:	File: TIDA-00642_CoverSheet.SchDoc	Size: B
Engineer: Wilson Zuo	Contact: http://www.ti.com/support	http://www.ti.com



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Orderable: N/A	Designed for: Public Release	Mod. Date: 11/10/2015
TID #: 00642	Project Title: Foot Controller Using Analog Hall Sensor	
Number: TIDA-00642 Rev: E1	Sheet Title:	
Revision: Version control disabled	Assembly Variant: [No Variations]	Sheet: 2 of 3
Drawn By: Wilson Zuo	File: TIDA-00642_SCH_SchDoc	Size: B
	Contact: http://www.ti.com/support	

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PCB Number: TIDA-00642
PCB Rev: RevA

PCB
LOGO
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PCB
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Pb-Free Symbol

You should delete the nylon screws/standoffs and/or the bump-ons as needed for your design (or substitute other parts from Hardware.Int.Lib). Bump-ons are cheaper, but provide less clearance.

Deleting anything else from this page may result in your EVM submission being rejected (until you add them back).

Update the Label Text in the Label Table as needed for each Assembly Variant.

You can delete this note too.

Label Table	
Variant	Label Text
001	ChangeMe!
002	ChangeMe!

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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